



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|----------------------|
| Footprint | 5634 |
| L | 5.59mm +/-0.38mm |
| W | 3.43mm +/-0.38mm |
| H | 1.78mm +/-0.38mm |
| S | 0.76mm +0.25/-0.13mm |
| F | 3.3mm +/-0.13mm |
| K | 1.02mm MIN |
| P | 0.51mm MIN |

Packaging Specifications

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|--------------------|------------|
| Packaging | T&R, 178mm |
| Packaging Quantity | 500 |

General Information

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|------------------|--|
| Series | T409 CWR09 |
| Dielectric | MnO ₂ Tantalum |
| Style | SMD Chip |
| Description | SMD, MnO ₂ , Molded, Military Equivalent |
| RoHS | No |
| Prop 65 | ⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov . |
| SCIP Number | 652b281f-d242-4453-bc44-0655d646cec3 |
| Termination | Hot Solder Dipped |
| Qualifications | MIL-PRF-55365/4, CWR09 Style |
| AEC-Q200 | No |
| Component Weight | 173.63 mg |
| Notes | Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S". |
| MSL | 1 |

Specifications

| | |
|-------------------------|-----------------------------|
| Capacitance | 10 uF |
| Capacitance Tolerance | 10% |
| Voltage DC | 15 VDC (85C), 10 VDC (125C) |
| Temperature Range | -55/+125°C |
| Rated Temperature | 85°C |
| Dissipation Factor | 6% 120Hz 25C |
| Failure Rate | C (0.01%/1000 Hrs) |
| Resistance | 2.5 Ohms (100kHz 25C) |
| Leakage Current | 2 uA (5min 25°C) |
| Testing and Reliability | Standard Testing Only |

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)